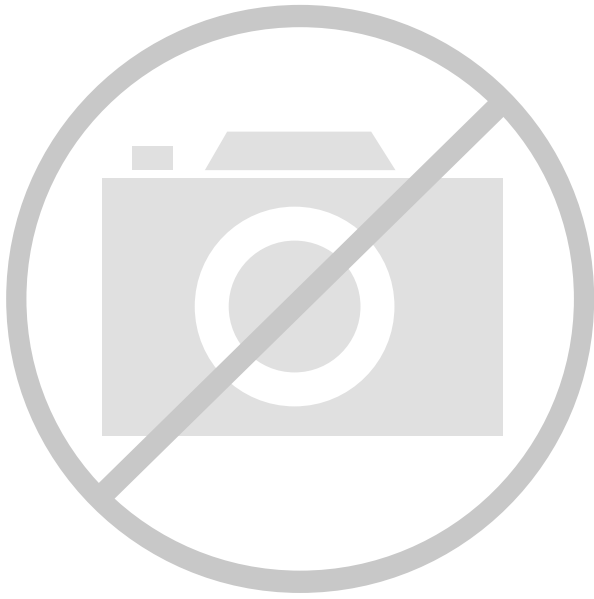




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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

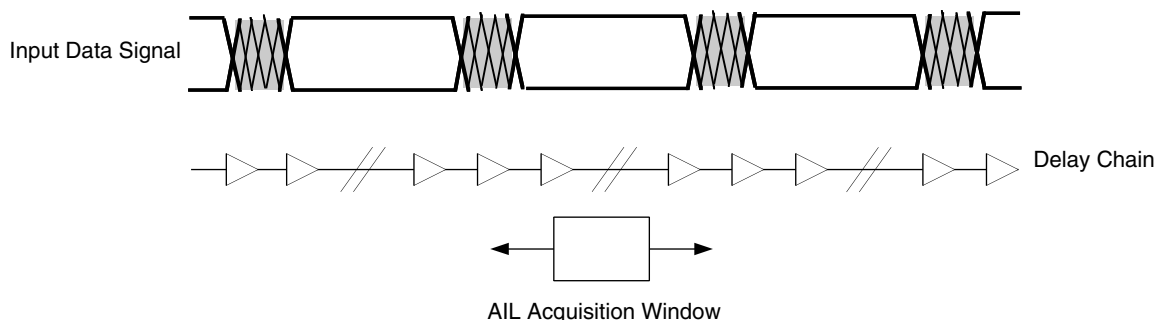
The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	10000
Number of Logic Elements/Cells	40000
Total RAM Bits	4075520
Number of I/O	562
Number of Gates	-
Voltage - Supply	0.95V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 105°C (TJ)
Package / Case	1020-BBGA, FCBGA
Supplier Device Package	1020-OFcBGA Rev 2 (33x33)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfsc3ga40e-5ffan1020i

Adaptive Input Logic (AIL) Overview

The Adaptive Input Logic (AIL) provides the ability of the input logic to dynamically find a solution by monitoring multiple samples of the input data. The input data signal from the input buffer is run through a delay chain. Data, transitions, jitter, noise are all contained inside of the delay chain. The AIL will then search the delay chain for a clean sampling point for data. Once found the AIL will monitor and walk with the data dynamically. This novel approach of using a delay chain to create multiple copies of the data provides a lower power solution than oversampling data with a higher speed clock. Figure 2-19 provides a high level view of the AIL methodology.

Figure 2-19. LatticeSC AIL Delay of Input Data Waveform

The AIL slides the acquisition window through the delay chain searching for stable data based solely on data transitions. A specific training pattern is not required to perform this bit alignment, simply data transitions. The size of the acquisition window is user-selectable allowing the AIL to operate over the full range of the PURESPEED I/O range. Based on dynamic user control the AIL can either continuously adjust the window location based on data edge detection or it can be locked to a specific delay.

The AIL operates on single data and double data rate interfaces and is available on most FPGA input pins on the LatticeSC device and all buffer types. The AIL block is low power using only 0.003 mW/MHz typical (6 mW @ 2 Gbps) for PRBS 2^7 data. Multiple AIL inputs can be used to create a bus with a FPGA circuit to realign the bus to a common clock cycle. The FPGA circuit to realign the bus is required and is provided by Lattice as a reference design.

For more information on the LatticeSC AIL please refer to TN1158 [LatticeSC PURESPEED I/O Adaptive Input Logic User's Guide](#).

Input DDR/Shift Block

The DDR/Shift block contains registers and associated logic that support DDR and shift register functions using the high-speed clock and the associated transfer to the low-speed clock domain. It functions as a gearbox allowing high-speed incoming data to be passed into the FPGA fabric. Each PIO supports DDR and x2 shift functions. If desired PIOs A and B or C and D can be combined to form x4 shift functions. The PIOs A and C on the left, right and bottom of the device also contain an optional Adaptive Input Logic (AIL) element. This logic automatically aligns incoming data with the clock allowing for easy design of high-speed interfaces. Figure 2-21 shows a simplified block diagram of the shift register block. The shift block in conjunction with the update and clock divider blocks automatically handles the hand off between the low-speed and high-speed clock domains.

Single Ended Inputs: The SC devices support a number of different termination schemes for single ended inputs:

- Parallel to V_{CCIO} or GND
- Parallel to $V_{CCIO}/2$
- Parallel to V_{TT}

Figure 2-28 shows the single ended input schemes that are supported. The nominal values of the termination resistors are shown in Table 2-9.

Figure 2-28. Input Termination Schemes

Termination Type	Discrete Off-Chip Solution	Lattice On-Chip Solution
Parallel termination to to V_{CCIO} , or parallel to GND receiving end		
Parallel termination to $V_{CCIO}/2$ receiving end		
Parallel termination to V_{TT} at receiving end		

In many situations designers can chose whether to use Thevenin or parallel to V_{TT} termination. The Thevenin approach has the benefit of not requiring a termination voltage to be applied to the device. The parallel to V_{TT} approach consumes less power.

VTT Termination Resources

Each I/O bank, except bank 1, has a number of V_{TT} pins that must be connected if V_{TT} is used. Note V_{TT} pins can sink or source current and the power supply they are connected to must be able to handle the relatively high currents associated with the termination circuits. Note: V_{TT} is not available in all package styles.

On-chip parallel termination to V_{TT} is supported at the receiving end only. On-chip parallel output termination to V_{TT} is not supported.

The V_{TT} internal bus is also connected to the internal V_{CMT} node. Thus in one bank designers can implement either V_{TT} termination or V_{CMT} termination for differential inputs.

DDRII/RLDRAMII Termination Support

The DDR II memory and RLDRAMII (in Bidirection Data mode) standards require that the on-chip termination to V_{TT} be turned on when a pin is an input and off when the pin is an output. The LatticeSC devices contain the required circuitry to support this behavior. For additional detail refer to technical information at the end of the data sheet.

flexiPCS quads are not dedicated solely to industry standard protocols. Each quad (and each channel within a quad) can be programmed for many user defined data manipulation modes. For example, modes governing user-defined word alignment and multi-channel alignment can be programmed for non-standard protocol applications.

For more information on the functions and use of the flexiPCS, refer to the [LatticeSC/M Family flexiPCS Data Sheet](#).

System Bus

Each LatticeSC device connects the FPGA elements with a standardized bus framework referred to as a System Bus. Multiple bus masters optimize system performance by sharing resources between different bus masters such as the MPI and configuration logic. The wide data bus configuration of 32 bits with 4-bit parity supports high-bandwidth, data intensive applications.

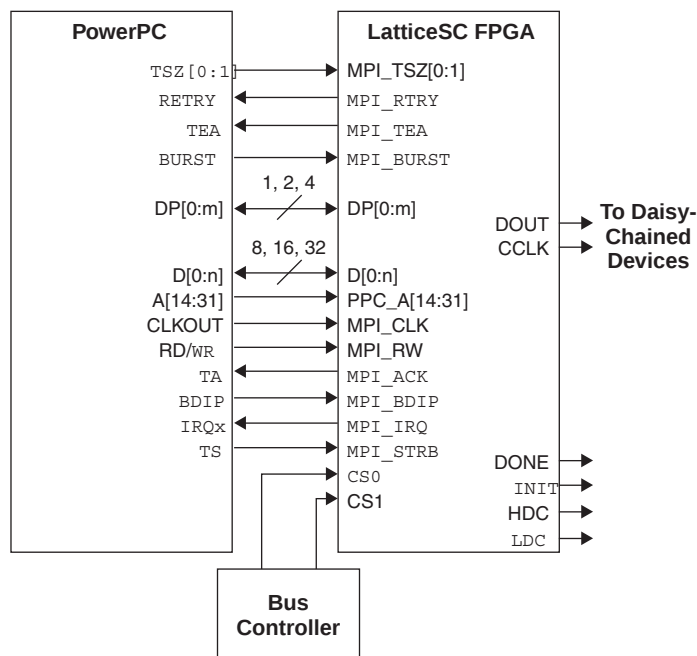
There are two types of interfaces on the System Bus, master and slave. A master interface has the ability to perform actions on the bus, such as writes and reads to and from a specific address. A slave interface responds to the actions of a master by accepting data and address on a write and providing data on a read. The System Bus has a memory map which describes each of the slave peripherals that is connected on the bus. Using the addresses listed in the memory map, a master interface can access each of the slave peripherals on the System Bus. Any and all peripherals on the System Bus can be used at the same time. Table 2-12 list all of the available user peripherals on the System Bus after device power-up.

Table 2-12. System Bus User Peripherals

Peripheral	Name	Interface Type
Micro Processor Interface	MPI	Master
User Master Interface	UMI	Master
User Slave Interface	USI	Slave
Serial Management Interface (PLL, DLL, User Logic)	SMI	Slave
Physical Coding Sublayer	PCS	Slave
Direct FPGA Access	DFA	Slave

The peripherals listed in Table 2-12 can be added when the System Bus module is created using Module IP/Manager (ispLEVER Module/IP Manager).

Figure 2-31 also lists the existing peripherals on the System Bus. The gray boxes are available only during configuration. Refer to Lattice technical note TN1080, [LatticeSC sysCONFIG Usage Guide](#), for configuration options. The Status and Config box refers to internal System Bus registers. This document presents all the interfaces listed in Table 2-12 in detail to help the user utilize the desired functions of the System Bus.

Figure 2-32. PowerPCI and MPI Schematic

Configuration and Testing

The following section describes the configuration and testing features of the LatticeSC family of devices.

IEEE 1149.1-Compliant Boundary Scan Testability

All LatticeSC devices have boundary scan cells that are accessed through an IEEE 1149.1 compliant test access port (TAP). This allows functional testing of the circuit board, on which the device is mounted, through a serial scan path that can access all critical logic nodes. Internal registers are linked internally, allowing test data to be shifted in and loaded directly onto test nodes, or test data to be captured and shifted out for verification. The test access port consists of dedicated I/Os: TDI, TDO, TCK and TMS. The test access port has its own supply voltage V_{CCJ} and can operate with LVCMOS33, 25 and 18 standards. For additional detail refer to technical information at the end of the data sheet.

Device Configuration

All LatticeSC devices contain three possible ports that can be used for device configuration. The serial port, which supports bit-wide configuration, and the sysCONFIG port that supports both byte-wide and serial configuration. The MPI port supports 8-bit, 16-bit or 32-bit configuration.

The serial port supports both the IEEE Std. 1149.1 Boundary Scan specification and the IEEE Std. 1532 In-System Configuration specification. The sysCONFIG port is a 20-pin interface with six of the I/Os used as dedicated pins and the rest being dual-use pins. When sysCONFIG mode is not used, these dual-use pins are available for general purpose I/O. All I/Os for the sysCONFIG and MPI ports are in I/O bank #1.

On power-up, the FPGA SRAM is ready to be configured with the sysCONFIG port active. The IEEE 1149.1 serial mode can be activated any time after power-up by sending the appropriate command through the TAP port. Once a configuration port is selected, that port is locked and another configuration port cannot be activated until the next re-initialization sequence. For additional detail refer to technical information at the end of the data sheet.

PURESPEED I/O Recommended Operating Conditions

Standard	V _{CCIO} (V)			V _{REF} (V)		
	Min.	Typ.	Max.	Min.	Typ.	Max.
LVC MOS 33	3.135	3.3	3.465	—	—	—
LVC MOS 25	2.375	2.5	2.625	—	—	—
LVC MOS 18	1.71	1.8	1.89	—	—	—
LVC MOS 15	1.425	1.5	1.575	—	—	—
LVC MOS 12	1.14	1.2	1.26	—	—	—
LV TTL	3.135	3.3	3.465	—	—	—
PCI33	3.135	3.3	3.465	—	—	—
PCIX33	3.135	3.3	3.465	—	—	—
PCIX15	1.425	1.5	1.575	0.49V _{CCIO}	0.5V _{CCIO}	0.51V _{CCIO}
AGP1X33	3.135	3.3	3.465	—	—	—
AGP2X33	3.135	3.3	3.465	0.39V _{CCIO}	0.4V _{CCIO}	0.41V _{CCIO}
SSTL18_I, II ³	1.71	1.8	1.89	0.833	0.9	0.969
SSTL25_I, II ³	2.375	2.5	2.625	1.15	1.25	1.35
SSTL33_I, II ³	3.135	3.3	3.465	1.3	1.5	1.7
HSTL15_I, II ³	1.425	1.5	1.575	0.68	0.75	0.9
HSTL15_III ^{1,3} and IV ^{1,3}	1.425	1.5	1.575	0.68	0.9	0.9
HSTL 18_I ³ , II ³	1.71	1.8	1.89	0.816	0.9	1.08
HSTL 18_III ^{1,3} , IV ^{1,3}	1.71	1.8	1.89	0.816	1.08	1.08
GTL12 ^{1,3} , GTLPLUS15 ^{1,3}	—	—	—	0.882	1.0	1.122
LVDS	—	—	—	—	—	—
Mini-LVDS	—	—	—	—	—	—
RSDS	—	—	—	—	—	—
LVPECL33 (outputs) ²	3.135	3.3	3.465	—	—	—
LVPECL33 (inputs) ^{2,4}	—	≤ 2.5	—	—	—	—
BLVDS25 ^{2,3}	2.375	2.5	2.625	—	—	—
MLVDS25 ^{2,3}	2.375	2.5	2.625	—	—	—
SSTL18D_I ³ , II ³	1.71	1.8	1.89	—	—	—
SSTL25D_I ³ , II ³	2.375	2.5	2.625	—	—	—
SSTL33D_I ³ , II ³	3.135	3.3	3.465	—	—	—
HSTL15D_I ³ , II ³	1.425	1.5	1.575	—	—	—
HSTL18D_I ³ , II ³	1.71	1.8	1.89	—	—	—

1. Input only.

2. Inputs on chip. Outputs are implemented with the addition of external resistors.

3. Input for this standard does not depend on the value of V_{CCIO}.

4. Inputs for this standard cannot be in 3.3V VCCIO banks (≤ 2.5V only).

sysCLOCK DLL Timing**Over Recommended Operating Conditions**

Parameter	Description	Conditions	Min.	Typ.	Max.	Units
f_{IN}	Input Clock Frequency (CLKI, CLKFB)		100	—	700	MHz
f_{OUTOP}	Output Clock Frequency (CLKOP)		100	—	700	MHz
f_{OUTOS}	Output Clock Frequency (CLKOS)		25	—	700	MHz
AC Characteristics						
t_{DUTY}	Output Clock Duty Cycle	Output Clock Duty Cycle (at 50% levels, 50% duty cycle input clock, duty cycle correction turned off, time reference delay mode)	38	—	62	%
t_{DUTYRD}	Output Clock Duty Cycle	Output Clock Duty Cycle (at 50% levels, arbitrary duty cycle input clock, duty cycle correction turned on, time reference delay mode)	45	—	55	%
$t_{DUTYCIR}$	Output Clock Duty Cycle	Output Clock Duty Cycle (at 50% levels, arbitrary duty cycle input clock, duty cycle correction turned on, clock injection removal mode)	40	—	60	%
t_{OPJIT}^1	Output Clock Period Jitter		—	—	200	ps
t_{CPJIT}^1	Output Clock Cycle-to-Cycle Jitter		—	—	200	ps
t_{SKEW}	Output Clock to Clock Skew (Between Two Outputs with the Same Phase Setting)		—	—	100	ps
t_{LOCK}	DLL Lock-in Time		8	—	18500	cycles
t_{IDUTY}	Input Clock Duty Cycle	Applies to all operating conditions	35	—	65	%
t_{IPJIT}	Input Clock Period Jitter		—	—	+/- 250	ps
t_{HI}	Input Clock High Time	At 80% level	500	—	—	ps
t_{LO}	Input Clock Low Time	At 20% level	500	—	—	ps
t_{RSWD}	Reset Signal Pulse Width		3	—	—	ns
t_{FDEL}	Timeshift Delay Step Size		35	45	80	ps
t_{DLL}	Delay Through the DLL when No Delay Taps are Chosen but Not in Bypass Mode.		—	760	—	ps

1. Values are measured with FPGA logic active, no additional I/Os toggling and REFCLK total jitter = 30 ps.

LatticeSC/M sysCONFIG Port Timing (Continued)

Over Recommended Operating Conditions

Parameter	Description	Min.	Max.	Units
sysCONFIG Asynchronous Peripheral Configuration Mode				
t_{WRAP}	WRN, CS0N and CS1 Pulse Width	5	-	ns
t_{SAP}	D[7:0] Setup Time	1.5	-	ns
t_{RDYAP}	RDY Delay	—	8	ns
t_{BAP}	RDY Low	1	8	CCLK periods
t_{WR2AP}	Earliest WRN After RDY Goes High	0	—	ns
t_{DENAP}	RDN to D[7:0] Enable/Disable	—	7.5	ns
t_{DAP}	CCLK to DOUT	—	7.5	ns
sysCONFIG Slave Serial Configuration Mode				
t_{SSS}	DIN Setup Time	5.2	—	ns
t_{HSS}	DIN Hold Time	0	—	ns
t_{CHSS}	CCLK High Time	3.75	—	ns
t_{CLSS}	CCLK Low Time	3.75	—	ns
f_{CSS}	CCLK Frequency	—	150	MHz
t_{DSS}	CCLK to DOUT	—	7.5	ns
sysCONFIG Slave Parallel Configuration Mode				
t_{S1SP}	CS0N, CS1, WRN Setup Time	5.2	—	ns
t_{H1SP}	CS0N, CS1, WRN Hold Time	0	—	ns
t_{S2SP}	D[7:0] Setup Time	5.2	—	ns
t_{H2SP}	D[7:0] Hold Time	0	—	ns
t_{CHSP}	CCLK High Time	3.75	—	ns
t_{CL}	CCLK Low Time	3.75	—	ns
f_{CSP}	CCLK Frequency	—	150	MHz

sysCONFIG MPI Port

Parameter	Description	-7		-6		-5		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
$t_{MPICTRL_SET}$	MPI Control (MPCSTRBN, MPCWRN, MPCCLK, etc.) to MPCCLK Setup Time	4.9	—	5.2	—	5.5	—	ns
t_{MPIADR_SET}	MPI Address to MPCCLK Setup Time	3.9	—	4.2	—	4.5	—	ns
t_{MPIDAT_SET}	MPI Write Data to MPCCLK Setup Time	4.9	—	5.2	—	5.5	—	ns
$t_{MPIDPAR_SET}$	MPI Write Parity Data to MPCCLK Setup Time	3.9	—	4.2	—	4.5	—	ns
t_{MPI_HLD}	All Hold Times	0	—	0	—	0	—	ns
$t_{MPICTRL_DEL}$	MPCCLK to MPI Control (MPCTA, MPC-TEA, MPCRETRY)	—	5.6	—	6.7	—	8.7	ns
t_{MPIDAT_DEL}	MPCCLK to MPI Data	—	5.6	—	6.7	—	8.7	ns
$t_{MPIDPAR_DEL}$	MPCCLK to MPI Parity Data	—	4.9	—	5.7	—	7.7	ns
$f_{MPI_CLK_FRQ}$	MPCCLK Frequency	—	100	—	83	—	66	MHz

Signal Descriptions (Cont.)

Signal Name	I/O	Description
MPI_STRBN	I	Driven active low indicates the start of a transaction on the PowerPC bus. MPI will strobe the address bus at next rising edge of clock.
MPI_ADDR[31:14]	I	Address bus driven by a PowerPC bus master. Only 18-bit width is needed. It has to be the least significant bit of the PowerPC 32-bit address A[31:14].
MPI_DAT[n:0]	I/O	Selectable data bus width from 8, and 16-bit. Driven by a bus master in a write transaction. Driven by MPI in a read transaction.
MPI_PAR[m:0]	I/O	Selectable parity bus width from 1, 2, and 3-bit. MPI_DP[0] for MPI_D[7:0], MPI_DP[1] for MPI_D[15:8] and MPI_DP[2] for MPI_D[23:16].
MPI_TA	O	Transfer acknowledge. Driven active low indicates that MPI received the data on the write cycle or returned data on the read cycle.
MPI_TEA	O	Transfer Error Acknowledge. Driven active low indicates that MPI detects a bus error on the internal system bus for current transaction.
MPI_RETRY	O	Active low MPI Retry requests the MPC860 to relinquish the bus and retry the cycle.
Multi-chip Alignment (User I/O if not used.)		
MCA_DONE_OUT	O	Multi-chip alignment done output (to second MCA chip)
MCA_DONE_IN	I	Multi-chip alignment done input (from second MCA chip)
MCA_CLK_P[1:2]_OUT	O	Multi-chip alignment clock [1:2] output (sourced by MCA master chip)
MCA_CLK_P[1:2]_IN	I	Multi-chip alignment clock [1:2] input (from MCA master chip)
TEMP	—	Temperature sensing diode pin. Dedicated pin. Accuracy is typically +/- 10°C.
Miscellaneous Dedicated Pins		
XRES	—	External reference resistor between this pin and ground. The reference resistor is used to calibrate the programmable terminating resistors used in the I/Os. Dedicated pin. Value: 1K ± 1% ohm.
DIFFRx	—	Only used if a differential driver is used in a bank. This DIFFRx must be connected to ground via an external 1K ±1% ohm resistor for all banks that have a differential driver.
SERDES Block (Dedicated Pins)		
[A:D]_HDINPx_[L/R]	I	High-speed input (positive) channel x on left [L] or right [R] side of device. PCS quad is defined in the dual function name column of the Logic Signal Connection table.
[A:D]_HDINNx_[L/R]	I	High-speed input (negative) channel x on left [L] or right [R] side of device. PCS quad is defined in the dual function name column of the Logic Signal Connection table.
[A:D]_HDOUTPx_[L/R]	O	High-speed output (positive) channel x on left [L] or right [R] side of device. PCS quad is defined in the dual function name column of the Logic Signal Connection table.
[A:D]_HDOUTNx_[L/R]	O	High-speed output (negative) channel x on left [L] or right [R] side of device. PCS quad is defined in the dual function name column of the Logic Signal Connection table.
[A:D]_REFCLKP_[L/R]	I	Ref clock input (positive), aux channel on left [L] or right [R] side of device.
[A:D]_REFCLKN_[L/R]	I	Ref clock input (negative), aux channel on left [L] or right [R] side of device.

Signal Descriptions (Cont.)

Signal Name	I/O	Description
RESP_[ULC/URC]	—	Calibration resistor to be placed between this pin and either ground or RESPN_[ULC/URC]. RESPN_[ULC/URC] is available on select packages. If available, connection of calibration resistor between RESP_[ULC/URC] and RESPN_[ULC/URC] takes precedence over connection of calibration resistor between RESP_[ULC/URC] and ground. Note: only one per side of the device. Value: 4.02K ohm +/- 1% ohm.
RESPN_[ULC/URC]	—	Available on selected packages. If available, calibration resistor should be placed between RESP_[ULC/URC] and RESPN_[ULC/URC] instead of between RESP_[ULC/URC] and ground. Note: only one per side of the device. Value: 4.02K ohm +/- 1% ohm.
[A:D]_VDDIBx_[L/R]	—	Input buffer power supply for channel x (1.2V/1.5V) on left [L] or right [R] side of device.
[A:D]_VDDOBx_[L/R]	—	Output buffer power supply for channel x (1.2V/1.5V) on left [L] or right [R] side of device.
[A:D]_VDDAX25_[L/R]	—	Auxiliary power for input and output termination (2.5V) on left [L] or right [R] side of device.

1. The ispLEVER software tools may specify VDDR_x, VDDT_x, VDDP and VCCL pins. These pins should be considered VCC12 pins.
Note: Signals listed as Signal A / Signal B define the same physical pin that is used for different functions based on configuration mode.

LFSC/M15 Logic Signal Connections: 256 fpBGA^{1,2} (Cont.)

Ball Number	LFSC/M15		
	Ball Function	VCCIO Bank	Dual Function
F14	PR17A	2	URC_DLLT_IN_C/URC_DLLT_FB_D
E15	PR15B	2	URC_PLLC_IN_A/URC_PLLC_FB_B
E14	PR15A	2	URC_PLLT_IN_A/URC_PLLT_FB_B
D9	VCCJ	-	
C16	TDO	-	TDO
B15	TMS	-	
B16	TCK	-	
E13	TDI	-	
C14	PROGRAMN	1	
C15	CCLK	1	
A15	PT43D	1	HDC/SI
A14	PT43C	1	LDCN/SCS
B14	PT41A	1	CS1
E12	PT39B	1	CS0N
D13	PT39A	1	RDN
D12	PT37D	1	WRN
E10	PT37C	1	D7
C11	PT37B	1	D6
D10	PT37A	1	D5
A13	PT36D	1	D4
B12	PT36C	1	D3
A12	PT35B	1	D2
C12	PT35A	1	D1
A11	PT33B	1	D0
B11	PT33A	1	QOUT/CEON
E9	PT32D	1	VREF2_1
E8	PT32B	1	DOUT
D8	PT28C	1	BUSYN/RCLK/SCK
A10	PT27B	1	PCLKC1_0
C10	PT27A	1	PCLKT1_0
E7	PT21C	1	VREF1_1
C9	A_VDDIB3_L	-	
A9	A_HDINP3_L	-	PCS 360 CH 3 IN P
B9	A_HDINN3_L	-	PCS 360 CH 3 IN N
A8	A_HDOUTP3_L	-	PCS 360 CH 3 OUT P
B8	A_HDOUTN3_L	-	PCS 360 CH 3 OUT N
C8	A_VDDOB3_L	-	
B7	A_HDOUTN2_L	-	PCS 360 CH 2 OUT N
C7	A_VDDOB2_L	-	
A7	A_HDOUTP2_L	-	PCS 360 CH 2 OUT P
B6	A_HDINN2_L	-	PCS 360 CH 2 IN N
A6	A_HDINP2_L	-	PCS 360 CH 2 IN P
C6	A_VDDIB2_L	-	

LFSC/M15 Logic Signal Connections: 256 fpBGA^{1,2} (Cont.)

Ball Number	LFSC/M15		
	Ball Function	VCCIO Bank	Dual Function
C5	A_VDDIB1_L	-	
A5	A_HDINP1_L	-	PCS 360 CH 1 IN P
B5	A_HDINN1_L	-	PCS 360 CH 1 IN N
A4	A_HDOUTP1_L	-	PCS 360 CH 1 OUT P
B4	A_HDOUTN1_L	-	PCS 360 CH 1 OUT N
C4	A_VDDOB1_L	-	
B3	A_HDOUTN0_L	-	PCS 360 CH 0 OUT N
C3	A_VDDOB0_L	-	
A3	A_HDOUTP0_L	-	PCS 360 CH 0 OUT P
B2	A_HDINN0_L	-	PCS 360 CH 0 IN N
A2	A_HDINP0_L	-	PCS 360 CH 0 IN P
C2	A_VDDIB0_L	-	
A1	GND	-	
A16	GND	-	
B10	GND	-	
C13	GND	-	
D15	GND	-	
D3	GND	-	
E11	GND	-	
F13	GND	-	
G14	GND	-	
G2	GND	-	
G8	GND	-	
H10	GND	-	
J7	GND	-	
K15	GND	-	
K3	GND	-	
K9	GND	-	
M6	GND	-	
N11	GND	-	
N14	GND	-	
N2	GND	-	
P10	GND	-	
P4	GND	-	
R13	GND	-	
R7	GND	-	
G10	VCC	-	
G7	VCC	-	
G9	VCC	-	
H7	VCC	-	
H8	VCC	-	
H9	VCC	-	
J10	VCC	-	
J8	VCC	-	

LFSC/M15, LFSC/M25 Logic Signal Connections: 900 fpBGA^{1, 2}

Ball Number	LFSC/M15			LFSC/M25		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
F7	A_VDDAX25_L	-		A_VDDAX25_L	-	
B1	A_REFCLKP_L	-		A_REFCLKP_L	-	
C1	A_REFCLKN_L	-		A_REFCLKN_L	-	
D5	VCC12	-		VCC12	-	
A2	RESP_ULC	-		RESP_ULC	-	
E5	VCC12	-		VCC12	-	
D4	VCC12	-		VCC12	-	
H5	RESETN	1		RESETN	1	
H6	TSALLN	1		TSALLN	1	
G6	DONE	1		DONE	1	
G5	INITN	1		INITN	1	
F5	M0	1		M0	1	
F6	M1	1		M1	1	
F4	M2	1		M2	1	
E4	M3	1		M3	1	
D3	PL15A	7	ULC_PLLT_IN_A/ULC_PLLT_FB_B	PL16A	7	ULC_PLLT_IN_A/ULC_PLLT_FB_B
D2	PL15B	7	ULC_PLLC_IN_A/ULC_PLLC_FB_B	PL16B	7	ULC_PLLC_IN_A/ULC_PLLC_FB_B
J6	PL15C	7		PL16C	7	
J5	PL15D	7		PL16D	7	
E3	PL17A	7	ULC_DLLT_IN_C/ULC_DLLT_FB_D	PL17A	7	ULC_DLLT_IN_C/ULC_DLLT_FB_D
E2	PL17B	7	ULC_DLLC_IN_C/ULC_DLLC_FB_D	PL17B	7	ULC_DLLC_IN_C/ULC_DLLC_FB_D
K4	PL17C	7	ULC_PLLT_IN_B/ULC_PLLT_FB_A	PL17C	7	ULC_PLLT_IN_B/ULC_PLLT_FB_A
J4	PL17D	7	ULC_PLLC_IN_B/ULC_PLLC_FB_A	PL17D	7	ULC_PLLC_IN_B/ULC_PLLC_FB_A
F3	PL18A	7	ULC_DLLT_IN_D/ULC_DLLT_FB_C	PL18A	7	ULC_DLLT_IN_D/ULC_DLLT_FB_C
G3	PL18B	7	ULC_DLLC_IN_D/ULC_DLLC_FB_C	PL18B	7	ULC_DLLC_IN_D/ULC_DLLC_FB_C
K5	PL18C	7		PL18C	7	
K6	PL18D	7	VREF2_7	PL18D	7	VREF2_7
F2	PL19A	7		PL22A	7	
F1	PL19B	7		PL22B	7	
E1	PL19C	7		PL22C	7	
D1	PL19D	7		PL22D	7	
K3	PL22A	7		PL25A	7	
L3	PL22B	7		PL25B	7	
L6	PL22C	7	VREF1_7	PL25C	7	VREF1_7
M6	PL22D	7	DIFFR_7	PL25D	7	DIFFR_7
J1	PL23A	7	PCLKT7_1	PL26A	7	PCLKT7_1
K1	PL23B	7	PCLKC7_1	PL26B	7	PCLKC7_1
L1	PL24A	7	PCLKT7_0	PL27A	7	PCLKT7_0
M1	PL24B	7	PCLKC7_0	PL27B	7	PCLKC7_0
P8	PL24C	7	PCLKT7_2	PL27C	7	PCLKT7_2
R8	PL24D	7	PCLKC7_2	PL27D	7	PCLKC7_2
N2	PL26A	6	PCLKT6_0	PL29A	6	PCLKT6_0
N1	PL26B	6	PCLKC6_0	PL29B	6	PCLKC6_0
R7	PL26C	6	PCLKT6_1	PL29C	6	PCLKT6_1
R6	PL26D	6	PCLKC6_1	PL29D	6	PCLKC6_1

LFSC/M15, LFSC/M25 Logic Signal Connections: 900 fpBGA^{1, 2} (Cont.)

Ball Number	LFSC/M15			LFSC/M25		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AK14	PB25A	5		PB35A	5	
AK15	PB25B	5		PB35B	5	
AK16	PB27A	4		PB37A	4	
AK17	PB27B	4		PB37B	4	
AJ16	PB28A	4		PB38A	4	
AJ17	PB28B	4		PB38B	4	
AE16	PB28C	4		PB38C	4	
AH16	PB29A	4		PB39A	4	
AG16	PB29B	4		PB39B	4	
AK18	PB31A	4		PB41A	4	
AK19	PB31B	4		PB41B	4	
AH17	PB32A	4		PB42A	4	
AH18	PB32B	4		PB42B	4	
AG17	PB32D	4		PB42D	4	
AJ18	PB33A	4		PB43A	4	
AJ19	PB33B	4		PB43B	4	
AK20	PB35A	4	PCLKT4_2	PB46A	4	PCLKT4_2
AK21	PB35B	4	PCLKC4_2	PB46B	4	PCLKC4_2
AF18	PB36A	4	PCLKT4_1	PB47A	4	PCLKT4_1
AG18	PB36B	4	PCLKC4_1	PB47B	4	PCLKC4_1
AJ20	PB37A	4	PCLKT4_0	PB49A	4	PCLKT4_0
AJ21	PB37B	4	PCLKC4_0	PB49B	4	PCLKC4_0
AG19	PB37C	4	VREF2_4	PB49C	4	VREF2_4
AK22	PB39A	4	PCLKT4_5	PB51A	4	PCLKT4_5
AK23	PB39B	4	PCLKC4_5	PB51B	4	PCLKC4_5
AH19	PB39C	4		PB51C	4	
AK24	PB40A	4	PCLKT4_3	PB52A	4	PCLKT4_3
AK25	PB40B	4	PCLKC4_3	PB52B	4	PCLKC4_3
AE19	PB40C	4	PCLKT4_4	PB52C	4	PCLKT4_4
AE20	PB40D	4	PCLKC4_4	PB52D	4	PCLKC4_4
AE21	PB41A	4		PB53A	4	
AF21	PB41B	4		PB53B	4	
AG21	PB43A	4		PB55A	4	
AG22	PB43B	4		PB55B	4	
AH22	PB44A	4		PB56A	4	
AH23	PB44B	4		PB56B	4	
AH21	PB44C	4		PB56C	4	
AK28	PB45A	4		PB60A	4	
AK29	PB45B	4		PB60B	4	
AE22	PB45C	4		PB60C	4	
AJ28	PB47A	4		PB67A	4	
AH28	PB47B	4		PB67B	4	
AE24	PB47C	4	VREF1_4	PB67C	4	VREF1_4
AE25	PB47D	4		PB67D	4	
AJ29	PB48A	4	LRC_DLLT_IN_C/LRC_DLLT_FB_D	PB68A	4	LRC_DLLT_IN_C/LRC_DLLT_FB_D

LFSC/M15, LFSC/M25 Logic Signal Connections: 900 fpBGA^{1, 2} (Cont.)

Ball Number	LFSC/M15			LFSC/M25		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AH20	NC	-		PB51D	4	
AK27	NC	-		NC	-	
AJ24	NC	-		NC	-	
AF17	NC	-		PB42C	4	
AH27	NC	-		PB61B	4	
AD23	NC	-		PB57A	4	
AE23	NC	-		PB57B	4	
AH24	NC	-		PB59A	4	
AH25	NC	-		PB59B	4	
AH26	NC	-		PB61A	4	
AF24	NC	-		PB63A	4	
AG24	NC	-		PB63B	4	
AG25	NC	-		PB64A	4	
AF25	NC	-		PB64B	4	
AG26	NC	-		PB65A	4	
AF27	NC	-		PB65B	4	
AD28	NC	-		PR56B	3	
AC27	NC	-		PR56A	3	
AE29	NC	-		PR53B	3	
AD29	NC	-		PR53A	3	
AB30	NC	-		NC	-	
AA28	NC	-		NC	-	
Y27	NC	-		PR47C	3	
W27	NC	-		PR47D	3	
V30	NC	-		PR47A	3	
W30	NC	-		PR47B	3	
W26	NC	-		PR43D	3	
V26	NC	-		PR43C	3	
U25	NC	-		PR42C	3	
T27	NC	-		PR40B	3	
R27	NC	-		PR40A	3	
V27	NC	-		PR39B	3	
U27	NC	-		PR39A	3	
U29	NC	-		PR36B	3	
T29	NC	-		PR36A	3	
T24	NC	-		PR35C	3	
Y25	NC	-		PR48C	3	
P24	NC	-		NC	-	
K28	NC	-		NC	-	
P23	NC	-		NC	-	
L28	NC	-		NC	-	
M27	NC	-		PR21B	2	
L27	NC	-		PR21A	2	
H27	NC	-		PR20B	2	
G27	NC	-		PR20A	2	

LFSC/M25, LFSC/M40 Logic Signal Connections: 1020 fcBGA^{1, 2}

Ball Number	LFSC/M25			LFSC/M40		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
C28	A_REFCLKP_L	-		A_REFCLKP_L	-	
D28	A_REFCLKN_L	-		A_REFCLKN_L	-	
B28	VCC12	-		VCC12	-	
F28	RESP_ULC	-		RESP_ULC	-	
J21	RESETN	1		RESETN	1	
J20	TSALLN	1		TSALLN	1	
K20	DONE	1		DONE	1	
K21	INITN	1		INITN	1	
K23	M0	1		M0	1	
J23	M1	1		M1	1	
J24	M2	1		M2	1	
K24	M3	1		M3	1	
K25	PL16A	7	ULC_PLLT_IN_A/ULC_PLLT_FB_B	PL16A	7	ULC_PLLT_IN_A/ULC_PLLT_FB_B
J25	PL16B	7	ULC_PLLC_IN_A/ULC_PLLC_FB_B	PL16B	7	ULC_PLLC_IN_A/ULC_PLLC_FB_B
K26	PL16C	7		PL16C	7	
K27	PL16D	7		PL16D	7	
D32	PL17A	7	ULC_DLLT_IN_C/ULC_DLLT_FB_D	PL17A	7	ULC_DLLT_IN_C/ULC_DLLT_FB_D
D31	PL17B	7	ULC_DLLC_IN_C/ULC_DLLC_FB_D	PL17B	7	ULC_DLLC_IN_C/ULC_DLLC_FB_D
M23	PL17C	7	ULC_PLLT_IN_B/ULC_PLLT_FB_A	PL17C	7	ULC_PLLT_IN_B/ULC_PLLT_FB_A
N23	PL17D	7	ULC_PLLC_IN_B/ULC_PLLC_FB_A	PL17D	7	ULC_PLLC_IN_B/ULC_PLLC_FB_A
E32	PL18A	7	ULC_DLLT_IN_D/ULC_DLLT_FB_C	PL18A	7	ULC_DLLT_IN_D/ULC_DLLT_FB_C
E31	PL18B	7	ULC_DLLC_IN_D/ULC_DLLC_FB_C	PL18B	7	ULC_DLLC_IN_D/ULC_DLLC_FB_C
J28	PL18C	7		PL18C	7	
K28	PL18D	7	VREF2_7	PL18D	7	VREF2_7
F32	PL20A	7		PL21A	7	
F31	PL20B	7		PL21B	7	
L25	PL20C	7		PL21C	7	
L26	PL20D	7		PL21D	7	
G31	PL21A	7		PL22A	7	
G32	PL21B	7		PL22B	7	
J29	PL22A	7		PL25A	7	
H29	PL22B	7		PL25B	7	
M25	PL22C	7		PL25C	7	
N25	PL22D	7		PL25D	7	
H31	PL25A	7		PL23A	7	
H32	PL25B	7		PL23B	7	
M24	PL25C	7	VREF1_7	PL23C	7	VREF1_7
N24	PL25D	7	DIFFR_7	PL23D	7	DIFFR_7
L32	PL26A	7	PCLKT7_1	PL35A	7	PCLKT7_1
M32	PL26B	7	PCLKC7_1	PL35B	7	PCLKC7_1
R25	PL26C	7	PCLKT7_3	PL35C	7	PCLKT7_3
R24	PL26D	7	PCLKC7_3	PL35D	7	PCLKC7_3
N31	PL27A	7	PCLKT7_0	PL36A	7	PCLKT7_0
N32	PL27B	7	PCLKC7_0	PL36B	7	PCLKC7_0
P27	PL27C	7	PCLKT7_2	PL36C	7	PCLKT7_2
P28	PL27D	7	PCLKC7_2	PL36D	7	PCLKC7_2
P30	PL29A	6	PCLKT6_0	PL38A	6	PCLKT6_0
P29	PL29B	6	PCLKC6_0	PL38B	6	PCLKC6_0
T23	PL29C	6	PCLKT6_1	PL38C	6	PCLKT6_1
T24	PL29D	6	PCLKC6_1	PL38D	6	PCLKC6_1

LFSC/M25, LFSC/M40 Logic Signal Connections: 1020 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M25			LFSC/M40		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
F19	PT24A	1	MPI_TEA	PT30A	1	MPI_TEA
J18	PT23D	1	D14/MPI_DATA14	PT28D	1	D14/MPI_DATA14
K18	PT23C	1	DP1/MPI_PAR1	PT28C	1	DP1/MPI_PAR1
E20	PT23B	1	A21/MPI_BURST	PT27B	1	A21/MPI_BURST
F20	PT23A	1	D15/MPI_DATA15	PT27A	1	D15/MPI_DATA15
C23	B_REFCLKP_L	-		B_REFCLKP_L	-	
D23	B_REFCLKN_L	-		B_REFCLKN_L	-	
B23	VCC12	-		VCC12	-	
H21	B_VDDIB3_L	-		B_VDDIB3_L	-	
F21	B_HDINP3_L	-	PCS 361 CH 3 IN P	B_HDINP3_L	-	PCS 361 CH 3 IN P
G21	B_HDINN3_L	-	PCS 361 CH 3 IN N	B_HDINN3_L	-	PCS 361 CH 3 IN N
A21	B_HDOUTP3_L	-	PCS 361 CH 3 OUT P	B_HDOUTP3_L	-	PCS 361 CH 3 OUT P
B21	B_HDOUTN3_L	-	PCS 361 CH 3 OUT N	B_HDOUTN3_L	-	PCS 361 CH 3 OUT N
D21	B_VDDOB3_L	-		B_VDDOB3_L	-	
B22	B_HDOUTN2_L	-	PCS 361 CH 2 OUT N	B_HDOUTN2_L	-	PCS 361 CH 2 OUT N
D22	B_VDDOB2_L	-		B_VDDOB2_L	-	
A22	B_HDOUTP2_L	-	PCS 361 CH 2 OUT P	B_HDOUTP2_L	-	PCS 361 CH 2 OUT P
G22	B_HDINN2_L	-	PCS 361 CH 2 IN N	B_HDINN2_L	-	PCS 361 CH 2 IN N
F22	B_HDINP2_L	-	PCS 361 CH 2 IN P	B_HDINP2_L	-	PCS 361 CH 2 IN P
H22	B_VDDIB2_L	-		B_VDDIB2_L	-	
H24	B_VDDIB1_L	-		B_VDDIB1_L	-	
G23	B_HDINP1_L	-	PCS 361 CH 1 IN P	B_HDINP1_L	-	PCS 361 CH 1 IN P
H23	B_HDINN1_L	-	PCS 361 CH 1 IN N	B_HDINN1_L	-	PCS 361 CH 1 IN N
A24	B_HDOUTP1_L	-	PCS 361 CH 1 OUT P	B_HDOUTP1_L	-	PCS 361 CH 1 OUT P
B24	B_HDOUTN1_L	-	PCS 361 CH 1 OUT N	B_HDOUTN1_L	-	PCS 361 CH 1 OUT N
D24	B_VDDOB1_L	-		B_VDDOB1_L	-	
B25	B_HDOUTN0_L	-	PCS 361 CH 0 OUT N	B_HDOUTN0_L	-	PCS 361 CH 0 OUT N
D25	B_VDDOB0_L	-		B_VDDOB0_L	-	
A25	B_HDOUTP0_L	-	PCS 361 CH 0 OUT P	B_HDOUTP0_L	-	PCS 361 CH 0 OUT P
G25	B_HDINN0_L	-	PCS 361 CH 0 IN N	B_HDINN0_L	-	PCS 361 CH 0 IN N
F25	B_HDINP0_L	-	PCS 361 CH 0 IN P	B_HDINP0_L	-	PCS 361 CH 0 IN P
H25	B_VDDIB0_L	-		B_VDDIB0_L	-	
H26	A_VDDIB3_L	-		A_VDDIB3_L	-	
F26	A_HDINP3_L	-	PCS 360 CH 3 IN P	A_HDINP3_L	-	PCS 360 CH 3 IN P
G26	A_HDINN3_L	-	PCS 360 CH 3 IN N	A_HDINN3_L	-	PCS 360 CH 3 IN N
A26	A_HDOUTP3_L	-	PCS 360 CH 3 OUT P	A_HDOUTP3_L	-	PCS 360 CH 3 OUT P
B26	A_HDOUTN3_L	-	PCS 360 CH 3 OUT N	A_HDOUTN3_L	-	PCS 360 CH 3 OUT N
D26	A_VDDOB3_L	-		A_VDDOB3_L	-	
B27	A_HDOUTN2_L	-	PCS 360 CH 2 OUT N	A_HDOUTN2_L	-	PCS 360 CH 2 OUT N
D27	A_VDDOB2_L	-		A_VDDOB2_L	-	
A27	A_HDOUTP2_L	-	PCS 360 CH 2 OUT P	A_HDOUTP2_L	-	PCS 360 CH 2 OUT P
G27	A_HDINN2_L	-	PCS 360 CH 2 IN N	A_HDINN2_L	-	PCS 360 CH 2 IN N
F27	A_HDINP2_L	-	PCS 360 CH 2 IN P	A_HDINP2_L	-	PCS 360 CH 2 IN P
H27	A_VDDIB2_L	-		A_VDDIB2_L	-	
F29	A_VDDIB1_L	-		A_VDDIB1_L	-	
G28	A_HDINP1_L	-	PCS 360 CH 1 IN P	A_HDINP1_L	-	PCS 360 CH 1 IN P
H28	A_HDINN1_L	-	PCS 360 CH 1 IN N	A_HDINN1_L	-	PCS 360 CH 1 IN N
A29	A_HDOUTP1_L	-	PCS 360 CH 1 OUT P	A_HDOUTP1_L	-	PCS 360 CH 1 OUT P
B29	A_HDOUTN1_L	-	PCS 360 CH 1 OUT N	A_HDOUTN1_L	-	PCS 360 CH 1 OUT N
D29	A_VDDOB1_L	-		A_VDDOB1_L	-	

LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M40			LFSC/M80		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AC19	VTT_5	5		VTT_5	5	
AC20	VTT_5	5		VTT_5	5	
AD22	VTT_5	5		VTT_5	5	
AB24	VTT_6	6		VTT_6	6	
W23	VTT_6	6		VTT_6	6	
Y23	VTT_6	6		VTT_6	6	
N24	VTT_7	7		VTT_7	7	
R23	VTT_7	7		VTT_7	7	
T23	VTT_7	7		VTT_7	7	
M12	VDDAX25_R	-		VDDAX25_R	-	
M23	VDDAX25_L	-		VDDAX25_L	-	
Y16	GND	-		GND	-	
Y14	GND	-		GND	-	
N21	VCC12	-		VCC12	-	
P22	VCC12	-		VCC12	-	
AA22	VCC12	-		VCC12	-	
AB21	VCC12	-		VCC12	-	
AB14	VCC12	-		VCC12	-	
AA13	VCC12	-		VCC12	-	
P13	VCC12	-		VCC12	-	
N14	VCC12	-		VCC12	-	
G26	NC	-		NC	-	
G9	NC	-		NC	-	
J12	NC	-		NC	-	
H12	NC	-		NC	-	
H23	NC	-		NC	-	
J23	NC	-		NC	-	

1. Differential pair grouping within a PCI is A (True) and B (complement) and C (True) and D (Complement).

2. The LatticeSC/M40 and LatticeSC/M80 in an 1152-pin package support a 32-bit MPI interface.

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AP26	PB41C	5		PB43C	5	
AN26	PB41D	5		PB43D	5	
AY30	PB43A	5		PB45A	5	
AY29	PB43B	5		PB45B	5	
AU30	PB43C	5		PB45C	5	
AU31	PB43D	5		PB45D	5	
AV27	PB44A	5		PB46A	5	
AV26	PB44B	5		PB46B	5	
AT28	PB44C	5		PB46C	5	
AT27	PB44D	5		PB46D	5	
BA29	PB45A	5		PB47A	5	
BA28	PB45B	5		PB47B	5	
AL25	PB45C	5		PB47C	5	
AM25	PB45D	5		PB47D	5	
BB29	PB47A	5		PB49A	5	
BB28	PB47B	5		PB49B	5	
AN25	PB47C	5		PB49C	5	
AP25	PB47D	5		PB49D	5	
AY27	PB48A	5	PCLKT5_3	PB50A	5	PCLKT5_3
AY26	PB48B	5	PCLKC5_3	PB50B	5	PCLKC5_3
AT25	PB48C	5	PCLKT5_4	PB50C	5	PCLKT5_4
AT24	PB48D	5	PCLKC5_4	PB50D	5	PCLKC5_4
AW27	PB49A	5	PCLKT5_5	PB51A	5	PCLKT5_5
AW26	PB49B	5	PCLKC5_5	PB51B	5	PCLKC5_5
AU29	PB49C	5		PB51C	5	
AU28	PB49D	5		PB51D	5	
BB27	PB51A	5	PCLKT5_0	PB53A	5	PCLKT5_0
BB26	PB51B	5	PCLKC5_0	PB53B	5	PCLKC5_0
AR25	PB51C	5		PB53C	5	
AR24	PB51D	5	VREF2_5	PB53D	5	VREF2_5
BA27	PB52A	5	PCLKT5_1	PB54A	5	PCLKT5_1
BA26	PB52B	5	PCLKC5_1	PB54B	5	PCLKC5_1
AP24	PB52C	5	PCLKT5_6	PB54C	5	PCLKT5_6
AN24	PB52D	5	PCLKC5_6	PB54D	5	PCLKC5_6
AV25	PB53A	5	PCLKT5_2	PB55A	5	PCLKT5_2
AV24	PB53B	5	PCLKC5_2	PB55B	5	PCLKC5_2
AU27	PB53C	5	PCLKT5_7	PB55C	5	PCLKT5_7
AU26	PB53D	5	PCLKC5_7	PB55D	5	PCLKC5_7
BA25	PB55A	5		PB57A	5	
BA24	PB55B	5		PB57B	5	
AU24	PB55C	5		PB57C	5	
AU25	PB55D	5		PB57D	5	
BB24	PB56A	5		PB58A	5	
BB25	PB56B	5		PB58B	5	
AM23	PB56C	5		PB58C	5	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
B22	PT61B	1	A3/MPI_ADDR17	PT69B	1	A3/MPI_ADDR17
B23	PT61A	1	A4/MPI_ADDR18	PT69A	1	A4/MPI_ADDR18
K23	PT60D	1	D25/PCLKC1_5/MPI_DATA25	PT66D	1	D25/PCLKC1_5/MPI_DATA25
J23	PT60C	1	D26/PCLKT1_5/MPI_DATA26	PT66C	1	D26/PCLKT1_5/MPI_DATA26
D22	PT60B	1	A5/MPI_ADDR19	PT66B	1	A5/MPI_ADDR19
E22	PT60A	1	A6/MPI_ADDR20	PT66A	1	A6/MPI_ADDR20
K22	PT59D	1	D27/MPI_DATA27	PT63D	1	D27/MPI_DATA27
J22	PT59C	1	VREF1_1	PT63C	1	VREF1_1
D23	PT59B	1	A7/MPI_ADDR21	PT63B	1	A7/MPI_ADDR21
C23	PT59A	1	A8/MPI_ADDR22	PT63A	1	A8/MPI_ADDR22
L23	PT57D	1	D28/PCLKC1_6/MPI_DATA28	PT61D	1	D28/PCLKC1_6/MPI_DATA28
M23	PT57C	1	D29/PCLKT1_6/MPI_DATA29	PT61C	1	D29/PCLKT1_6/MPI_DATA29
A24	PT57B	1	A9/MPI_ADDR23	PT61B	1	A9/MPI_ADDR23
B24	PT57A	1	A10/MPI_ADDR24	PT61A	1	A10/MPI_ADDR24
K25	PT56D	1	D30/PCLKC1_7/MPI_DATA30	PT58D	1	D30/PCLKC1_7/MPI_DATA30
J25	PT56C	1	D31/PCLKT1_7/MPI_DATA31	PT58C	1	D31/PCLKT1_7/MPI_DATA31
F23	PT56B	1	A11/MPI_ADDR25	PT58B	1	A11/MPI_ADDR25
F22	PT56A	1	A12/MPI_ADDR26	PT58A	1	A12/MPI_ADDR26
J26	PT55D	1	D11/MPI_DATA11	PT57D	1	D11/MPI_DATA11
K26	PT55C	1	D12/MPI_DATA12	PT57C	1	D12/MPI_DATA12
E23	PT55B	1	A13/MPI_ADDR27	PT57B	1	A13/MPI_ADDR27
E24	PT55A	1	A14/MPI_ADDR28	PT57A	1	A14/MPI_ADDR28
G23	PT53D	1	A16/MPI_ADDR30	PT55D	1	A16/MPI_ADDR30
G24	PT53C	1	D13/MPI_DATA13	PT55C	1	D13/MPI_DATA13
F26	PT53B	1	A15/MPI_ADDR29	PT55B	1	A15/MPI_ADDR29
F27	PT53A	1	A17/MPI_ADDR31	PT55A	1	A17/MPI_ADDR31
H25	PT52D	1	A19/MPI_TSI21	PT54D	1	A19/MPI_TSI21
H24	PT52C	1	A20/MPI_BDIP	PT54C	1	A20/MPI_BDIP
C25	PT52B	1	A18/MPI_TSI20	PT54B	1	A18/MPI_TSI20
C26	PT52A	1	MPI_TEA	PT54A	1	MPI_TEA
K24	PT51D	1	D14/MPI_DATA14	PT51D	1	D14/MPI_DATA14
J24	PT51C	1	DP1/MPI_PAR1	PT51C	1	DP1/MPI_PAR1
F24	PT51B	1	A21/MPI_BURST	PT51B	1	A21/MPI_BURST
F25	PT51A	1	D15/MPI_DATA15	PT51A	1	D15/MPI_DATA15
L26	D_REFCLKP_L	-		D_REFCLKP_L	-	
M26	D_REFCLKN_L	-		D_REFCLKN_L	-	
G27	VCC12	-		VCC12	-	
C29	D_VDDIB3_L	-		D_VDDIB3_L	-	
F28	VCC12	-		VCC12	-	
D26	D_HDINP3_L	-	PCS 363 CH 3 IN P	D_HDINP3_L	-	PCS 363 CH 3 IN P
E26	D_HDINN3_L	-	PCS 363 CH 3 IN N	D_HDINN3_L	-	PCS 363 CH 3 IN N
B25	D_HDOUTP3_L	-	PCS 363 CH 3 OUT P	D_HDOUTP3_L	-	PCS 363 CH 3 OUT P
D24	VCC12	-		VCC12	-	
A25	D_HDOUTN3_L	-	PCS 363 CH 3 OUT N	D_HDOUTN3_L	-	PCS 363 CH 3 OUT N
E25	D_VDDOB3_L	-		D_VDDOB3_L	-	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AW25	VCCIO5	-		VCCIO5	-	
AW31	VCCIO5	-		VCCIO5	-	
AW37	VCCIO5	-		VCCIO5	-	
AY22	VCCIO5	-		VCCIO5	-	
AY28	VCCIO5	-		VCCIO5	-	
AY34	VCCIO5	-		VCCIO5	-	
AB39	VCCIO6	-		VCCIO6	-	
AC36	VCCIO6	-		VCCIO6	-	
AD32	VCCIO6	-		VCCIO6	-	
AE40	VCCIO6	-		VCCIO6	-	
AF35	VCCIO6	-		VCCIO6	-	
AG31	VCCIO6	-		VCCIO6	-	
AH39	VCCIO6	-		VCCIO6	-	
AJ36	VCCIO6	-		VCCIO6	-	
AK32	VCCIO6	-		VCCIO6	-	
AL40	VCCIO6	-		VCCIO6	-	
AM35	VCCIO6	-		VCCIO6	-	
AP39	VCCIO6	-		VCCIO6	-	
AR36	VCCIO6	-		VCCIO6	-	
AU40	VCCIO6	-		VCCIO6	-	
AA40	VCCIO7	-		VCCIO7	-	
H36	VCCIO7	-		VCCIO7	-	
J40	VCCIO7	-		VCCIO7	-	
L35	VCCIO7	-		VCCIO7	-	
M39	VCCIO7	-		VCCIO7	-	
P36	VCCIO7	-		VCCIO7	-	
R40	VCCIO7	-		VCCIO7	-	
T31	VCCIO7	-		VCCIO7	-	
U35	VCCIO7	-		VCCIO7	-	
V39	VCCIO7	-		VCCIO7	-	
W32	VCCIO7	-		VCCIO7	-	
Y36	VCCIO7	-		VCCIO7	-	
AA14	VTT_2	2		VTT_2	2	
AA15	VTT_2	2		VTT_2	2	
R12	VTT_2	2		VTT_2	2	
V14	VTT_2	2		VTT_2	2	
AB14	VTT_3	3		VTT_3	3	
AB15	VTT_3	3		VTT_3	3	
AE14	VTT_3	3		VTT_3	3	
AJ13	VTT_3	3		VTT_3	3	
AH21	VTT_4	4		VTT_4	4	
AJ18	VTT_4	4		VTT_4	4	
AJ19	VTT_4	4		VTT_4	4	
AJ20	VTT_4	4		VTT_4	4	
AJ21	VTT_4	4		VTT_4	4	